FL850-03-80

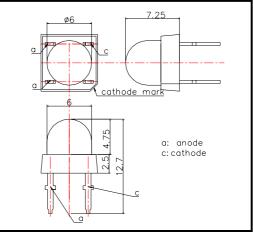
High Power type LED

FL850-03-80 is an AlGaAs LED mounted on a lead frame and molded with super beam lens. On forward bias, it emits a band of visible light which peaks 850nm.

These devices are intended to be operated at pulsed current of 4A under maximum 4.5V for stable long life. Outer dimension (Unit: mm)

Specifications

1) Product Name	Super Flux	mold type LED
2) Type No.	FL850-03-80)
3) Chip		
(1) Chip Material	GaAlAs	
(2) Chip Dimension	800um*800u	IM
(3) Peak Wavelength	850nm typ.	
4) Package		
(1) Type	Super Beam	type LED
(2) Resin Material	Epoxy Resin	I
(3) Lead Frame	Soldered	



♦ Absolute Maximum Ratings

Item	Symbol	Maximum Rated Value	Unit	Ambient Temperature		
Power Dissipation	PD	310	mW	Ta=25°C		
Forward Current	lf	200	mA	Ta=25°C		
Pulse Forward Current	lfp	4000	mA	Ta=25°C		
Reverse Voltage	Vr	10	V	Ta=25°C		
Operating Temperature	Topr	-30 ~ +85	°C			
Storage Temperature	Tstg	-30 ~ +100	°C			
Soldering Temperature	Tsol	260	°C			

‡Pulse Forward Current condition: Duty=1% and Pulse Width=10us.‡Soldering condition: Soldering condition must be completed within 3 seconds at 260°C

◆Electro-Optical Characteristics [Ta=25°C]

Item	Symbol	Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	Vf	IF=100mA		1.4	1.5	V
Pulsed Forward Voltage	Vf	Ifp=4A		3.3	4.5	V
Reverse Current	Ir	Vr=10V			10	uA
Total Radiated Power	Po	IF=100mA	35.0	60.0		mW
Radiant Intensity	ΙE	IF=100mA		230		mW/sr
Peak Wavelength	λΡ	I⊧=50mA	840	850	860	nm
Half Width	Δλ	IF=50mA		40		nm
Viewing Half Angle	θ 1/2	I⊧=50mA		±8		deg.
Rise Time	tr	IF=50mA		15		ns
Fall Time	tf	IF=50mA		10		ns

‡Total Radiated Power is measured by Photodyne #500

‡Radiant Intensity is measured by Tektronix J-6512.